18W, 12.5V High Power RF LDMOS FETs

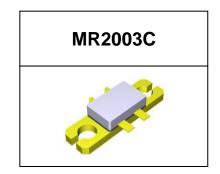
Description

The MR2003C is a 18-watt, Push-Pull configuration, unmatched LDMOS FETs, designed for ISM and Mobile radio applications with frequencies under 2GHz. It can be used in Class AB/B and Class C for all typical modulation formats.

It can also operate at 13.6V, 14V etc with increased power capability.

- Typical Performance (On Innogration fixture with device soldered): V_{DD} = 12.5 Volts, I_{DQ} = 150 mA, CW.

Freq(MHz)	Pin(dBm)	Pout(dBm)	Pout(W)	IDS(A)	Gain(dB)	Eff(%)
100	28	42.4	17.4	2.34	14.4	59.4%
150	26.8	42.5	17.8	2.4	15.7	59.3%
200	26.9	42.4	17.4	2.38	15.5	58.4%
250	28.8	42.8	19.1	2.45	14	62.2%
300	27.2	42.5	17.8	2.15	15.3	66.2%
350	25.4	42	15.8	1.89	16.6	67.1%
400	26.6	41.9	15.5	1.86	15.3	66.6%
450	28.3	42.4	17.4	2.31	14.1	60.2%
500	27.8	42.3	17.0	2.24	14.5	60.7%
550	27.7	42	15.8	2.12	14.3	59.8%



Features

- High Efficiency and Linear Gain Operations
- Integrated ESD Protection
- Excellent thermal stability, low HCI drift

Suitable Applications

- HF Amplifier
- UHF Amplifier
- Vehicle radio

- Large Positive and Negative Gate/Source Voltage Range for Improved Class C Operation
- Pb-free, RoHS-compliant
- VHF Amplifier
- Wideband Amplifier
- Beidou Navigation

Table 1. Maximum Ratings

Rating	Symbol	Value	Unit	
DrainSource Voltage	V _{DSS}	+65	Vdc	
GateSource Voltage	V _{GS}	-10 to +10		
Operating Voltage	V _{dd}	+28		
Storage Temperature Range	Tstg	-65 to +150	°C	
Case Operating Temperature	T _c	+150		
Operating Junction Temperature	L	+225	°C	
Table 2. Thermal Characteristics				
Characteristic	Symbol	Value	Unit	

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Thermal Resistance, Junction to Case						
T _C = 85°C, T _J =200°C, DC test	Rejc	Rejc 1		°C/	W	
Table 3. ESD Protection Characteristics	•			L		
Test Methodology			Class			
Human Body Model (per JESD22A114)		Class 2				
Table 4. Electrical Characteristics (T _A = 25 °C unless otherwise noted)						
Characteristic	Symbol	Min	Тур	Max	Unit	
DC Characteristics (per half section)	·					
Drain-Source Voltage		65	70		v	
V _{GS} =0, I _{DS} =1.0mA	$V_{(BR)DSS}$					
Zero Gate Voltage Drain Leakage Current	l	DSS		1	μΑ	
$(V_{DS} = 28 \text{ V}, V_{GS} = 0 \text{ V})$	IDSS					
GateSource Leakage Current	I _{GSS}			1	μΑ	
$(V_{GS} = 9 \text{ V}, V_{DS} = 0 \text{ V})$	GSS					
Gate Threshold Voltage	V _{gs} (th)		2.17		V	
$(V_{DS} = 28V, I_D = 600 \ \mu A)$	V GS(UI)					
Common Source Input Capacitance	C _{ISS}		15.7		pF	
$(V_{GS} = 0V, V_{DS} = 14 V, f = 1 MHz)$					P1	
Common Source Output Capacitance	C _{oss}		6.0		pF	
$(V_{GS} = 0V, V_{DS} = 14 V, f = 1 MHz)$			0.0		P.	
Common Source Feedback Capacitance	C _{RSS}		0.42		pF	
$(V_{GS} = 0V, V_{DS} = 14 V, f = 1 MHz)$	-100				F.	
Common Source Input Capacitance	C _{ISS}		16.0		pF	
$(V_{GS} = 0V, V_{DS} = 28 V, f = 1 MHz)$						
Common Source Output Capacitance	Coss		4.6		pF	
$(V_{GS} = 0V, V_{DS} = 28 V, f = 1 MHz)$	- 000					
Common Source Feedback Capacitance	C _{RSS}		0.38		pF	
$(V_{GS} = 0V, V_{DS} = 28 V, f = 1 MHz)$	- 1100					

Functional Tests (On Demo Test Fixture, 50 ohm system) V_{DD} = 12.5 Vdc, I_{DQ} = 150mA, f = 500 MHz ,CW Signal Measurements,

Pin=27.8dBm

Power Gain	Gp		14.5		dB
Drain Efficiency@Pout	η_{D}		60		%
Output Power	Pout		17		W
Input Return Loss	IRL		-5		dB
Load Mismatch (In Innogration Test Fixture, 50 ohm system): V _{DD} = 12.5 Vdc, I _{DQ} = 150 mA, f = 500 MHz					
VSWR 10:1 at 18W pulse CW Output Power No Device Degradation					

TYPICAL CHARACTERISTICS

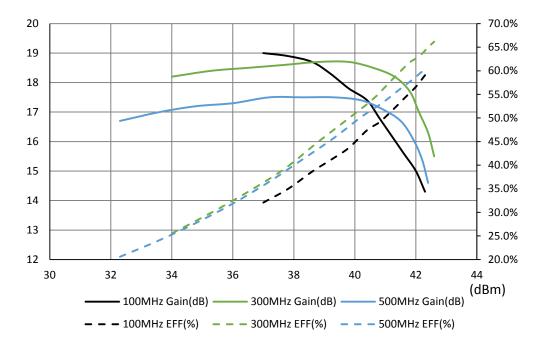
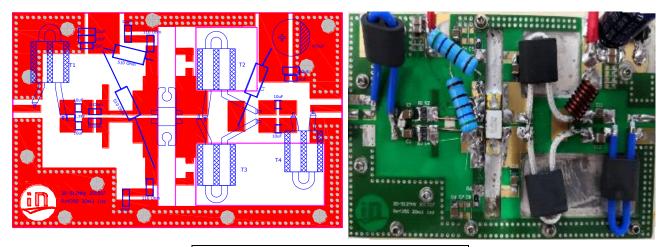


Figure 1: Power gain and drain efficiency as function of Pulse output power

Figure 2: 108-512MHz wideband application circuit picture (PCB Materials: Roger 4350B, 30Mil, Layout file upon request)



BOM			
L1	6uH 5A air core inductance		
T1, T4	magnetic core: BN-61-102		
	RF cable: SF-086-50, 70mm length		
Т2, Т3	magnetic core: BN-61-102		
	RF cable: SFF-25-1.5, 70mm		
	length		

Package Outline

Flanged ceramic package; 2 mounting holes; 4 leads

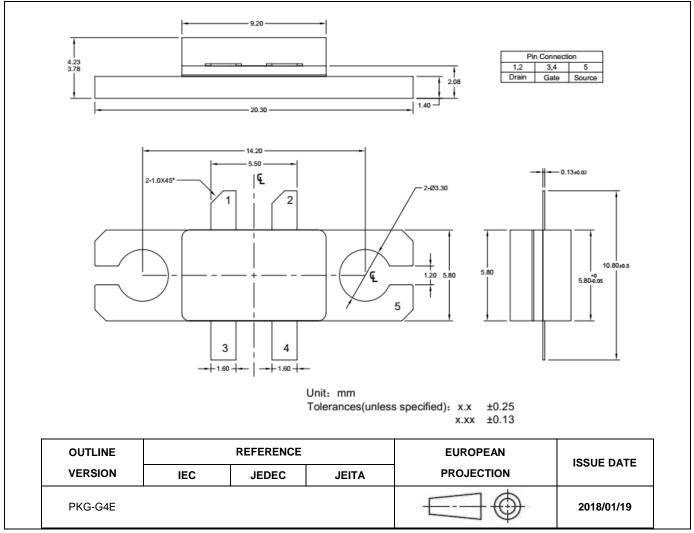


Figure 1. Package Outline PKG-G4E

Revision history

Table 5. Document revision history

Date	Revision	Datasheet Status
2018/6/14	Rev 1.0	Preliminary Datasheet
2018/9/16	Rev 1.1	12.5V data added

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